

07-24-2002



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To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

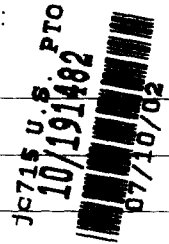
Ki-Hwan PARK
Jong-Sub HWANG
Jeong-Hwan KIM

7.10.02

2. Name and address of receiving party(ies):

Name: Samsung Electronics Co., Ltd.

Address: 416 Maetan-dong, Paldal-gu



Additional names(s) of conveying party(ies)

☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment

☐ Merger

☐ Security Agreement

☐ Change of Name

☐ Other

City: Suwon-city, Kyungki-do

State/Prov.:

Country: Republic of Korea

ZIP:

Execution Date: July 4, 2002

Additional name(s) & address(es)

☐ Yes ☒ No

4. Application number(s) or patent numbers(s):

10/191482

If this document is being filed together with a new application, the execution date of the application is: July 4, 2002

Patent Application No.

Filing date

B. Patent No.(s)

NEW

July 10, 2002

Additional numbers

☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: ANDREW J. TELESZ, JR.

Registration No. 33,581

Address: VOLENTINE FRANCOS, P.L.L.C.

12200 SUNRISE VALLEY DRIVE, SUITE 150

07/23/2002 T01A21 00000000 500238 10191482

01 FC:581 40.00 CH

City: RESTON

State/Prov.: VA

Country: USA

ZIP: 20191

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41):.....\$ 40.00

☐ Enclosed - Any excess or insufficiency should be credited or debited to deposit account

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50-0238

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

ANDREW J. TELESZ, JR.

Name of Person Signing

Signature

July 10, 2002

Date

Total number of pages including cover sheet, attachments, and

3

ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned

Insert

**Name(s) of
Inventor(s)**

1. PARK, Ki-Hwan

2. HWANG, Jong-Sub

3. KIM, Jeong-Hwan

Insert

**Name(s) of
Assignee(s)**

the undersigned hereby sell(s) and assign(s) to

Samsung Electronics Co., Ltd.

of 416 Maetan-dong, Paldal-gu, Suwon-city, Kyungki-do, Republic of Korea

**Title of
Invention**

(hereinafter designated as the Assignee) the entire right, title and interest for the United States as defined in 35 USC 100, in the invention known as

APPARATUS AND METHOD FOR SENSING DEFECTS IN TEMPERATURE
SENSORS

**Date of
Signing of
Application**

for which an application for patent in the United States of America has been executed by the undersigned on JUN 4, 2002

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuing, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) to Adam C. Volentine, Reg. No. 33,289 and William S. Francos, Reg. No. 38,456, and the firm of VOLENTINE FRANCOS, P.L.L.C. the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

| | |
|------------------------|--|
| Date <u>2002. 7. 4</u> | , Name of Inventor <u>Ki-Hwan Park</u> |
| Date <u>2002. 7. 4</u> | , Name of Inventor <u>Jong-Sub HWANG</u> |
| Date <u>2002. 7. 4</u> | , Name of Inventor <u>Jeong-Hwan KIM</u> |
| Date _____ | , Name of Inventor _____ |
| Date _____ | , Name of Inventor _____ |
| Date _____ | , Name of Inventor _____ |

(Note regarding Witnessing and/or Acknowledgment: Acknowledgment before a United States Consul is preferred but not required. If not acknowledged, then it is recommended that the execution by the Inventor(s) be witnessed by at least two witnesses who sign here. However, the current practice of the U.S. Patent and Trademark Office is to record an Assignment even it has not been acknowledged and/or witnessed.)

Witness _____

Witness _____

ACKNOWLEDGMENT

? _____

Applicant Reference No. PX1433-US/SSD Atty Docket No. SEC.950